MCP9600

Thermocouple EMF to Temperature Converter,
±1.5°C Maximum Accuracy

Features

• Thermocouple Electromotive Force (EMF) to °C Converter:
  - Integrated Cold-Junction Compensation
• Supported Types (designated by NIST ITS-90):
  - Type K, J, T, N, S, E, B and R
• ±1.5°C (Max.) Hot-Junction Accuracy
• Measurement Resolution:
  - Hot and Cold-Junctions: +0.0625°C (typical)
• Four Programmable Temperature Alert Outputs:
  - Monitor Hot or Cold-Junction Temperatures
  - Detect Rising or Falling Temperatures
  - Up to 255°C of Programmable Hysteresis
• Programmable Digital Filter for Temperature
• Low Power:
  - Shutdown Mode
  - Burst Mode: 1 to 128 Temperature Samples
• 2-Wire Interface: I2C Compatible, 100 kHz:
  - Supports Eight Devices per I2C Bus
• Operating Voltage Range: 2.7V to 5.5V
• Operating Current: 300 µA (typical)
• Shutdown Current: 2 µA (typical)
• Package: 20-lead MQFN

Typical Applications

• Petrochemical Thermal Management
• Hand-Held Measurement Equipment
• Industrial Equipment Thermal Management
• Ovens
• Industrial Engine Thermal Monitor
• Temperature Detection Racks

Description

Microchip Technology Inc.’s MCP9600 converts thermocouple EMF to degree Celsius with integrated cold-junction compensation. This device corrects the thermocouple nonlinear error characteristics of eight thermocouple types and outputs ±1.5°C accurate temperature data for the selected thermocouple. The correction coefficients are derived from the National Institute of Standards and Technology (NIST) ITS-90 Thermocouple Database.

The MCP9600 digital temperature sensor comes with user-programmable registers which provide design flexibility for various temperature sensing applications. The registers allow user-selectable settings, such as Low-Power modes for battery-powered applications, adjustable digital filter for fast transient temperatures and four individually programmable temperature alert outputs which can be used to detect multiple temperature zones.

The temperature alert limits have multiple user-programmable configurations, such as alert polarity as either an active-low or active-high push-pull output, and output function as a Comparator mode (useful for thermostat-type operation) or Interrupt mode for microprocessor-based systems. In addition, the alerts can detect either a rising or a falling temperature with up to +255°C hysteresis.

This sensor uses an industry standard 2-wire, I2C compatible serial interface and supports up to eight devices per bus by setting the device address using the ADDR pin.

Package Type

<table>
<thead>
<tr>
<th>MCP9600</th>
<th>5x5 MQFN*</th>
</tr>
</thead>
</table>

* Includes Exposed Thermal Pad (EP); see Table 3-1.
MCP9600 Registers

MCP9600 Evaluation Board (ADM00665)
1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings†

- $V_{DD} = 6.0V$
- Voltage at All Input/Output Pins: GND – 0.3V to 6.0V
- Storage Temperature: -65°C to +150°C
- Ambient Temperature with Power Applied: -40°C to +125°C
- Junction Temperature ($T_J$): +150°C
- ESD Protection on All Pins (HBM:MM): (4 kV:300V)
- Latch-up Current at Each Pin: ±100 mA

† Notice: Stresses above those listed under “Maximum ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

DC CHARACTERISTICS

Electrical Specifications: Unless otherwise indicated, $V_{DD} = 2.7V$ to 5.5V, GND = Ground, $T_A = -40°C$ to +125°C (where: $T_A = T_C$, defined as Device Ambient Temperature).

<table>
<thead>
<tr>
<th>Parameters</th>
<th>Sym.</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Unit</th>
<th>Conditions</th>
</tr>
</thead>
<tbody>
<tr>
<td>$T_H$ Hot-Junction Accuracy ($V_{DD} = 3.3V$)</td>
<td>$T_H = T_C + T_{\Delta}$ (Note 1)</td>
<td>THACY</td>
<td>-1.5</td>
<td>±0.5</td>
<td>+1.5</td>
<td>°C</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>-3.0</td>
<td>±1</td>
<td>+3.0</td>
<td>°C</td>
</tr>
<tr>
<td>$T_C$ Cold-Junction Accuracy ($V_{DD} = 3.3V$)</td>
<td>TCACY</td>
<td>-1.0</td>
<td>±0.5</td>
<td>+1.0</td>
<td>°C</td>
<td>$T_A = 0°C$ to +85°C</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>-2.0</td>
<td>±1</td>
<td>+2.0</td>
<td>°C</td>
</tr>
<tr>
<td>$T_{\Delta}$ Junctions Temperature Delta Accuracy</td>
<td>$T_{\Delta一个重要”的定义是器件的热电势与摄氏度之间的偏差。$T_A = 0°C$ to +85°C, $V_{DD} = 3.3V$ (Note 2)</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

Note 1: The $T_C$ and $T_{\Delta}$ summation is implemented in milli-volt (mV) domain. The result, $T_H$ (mV), is converted to Degree Celsius using the NIST ITS-90 Conversion database.

2: The $T_{\DeltaACY}$ temperature accuracy specification is defined as the device accuracy to the NIST ITS-90 Thermocouple EMF to Degree Celsius Conversion Database. $T_{\Delta}$ is also defined as the temperature difference between the hot and cold-junctions or temperatures from the NIST ITS-90 database with $T_C = 0°C$.

3: The device measures temperature below the specified range, however, the sensitivity to changes in temperature reduces exponentially. Type R and S measure down to -50°C, or -0.226 mV EMF and -0.235 mV EMF, respectively. Type N measures down to 500°C or 1.242 mV EMF (see Figures 2-7, 2-8, 2-10, 2-11, 2-14 and 2-17).

4: Exceeding the $V_{IN, CM}$ input range may cause leakage current through the ESD protection diodes at the thermocouple input pins. This parameter is characterized but not production tested.
### DC CHARACTERISTICS (CONTINUED)

#### Electrical Specifications:
Unless otherwise indicated, \( V_{DD} = 2.7 \)V to 5.5V, GND = Ground, \( T_A = -40^\circ C \) to +125°C (where: \( T_A = T_C \), defined as Device Ambient Temperature).

<table>
<thead>
<tr>
<th>Parameters</th>
<th>Sym.</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Unit</th>
<th>Conditions</th>
</tr>
</thead>
<tbody>
<tr>
<td>( T_C ) and ( T_H ) Temperature Resolution</td>
<td>( T_{RES} )</td>
<td>( \pm 0.0625 )</td>
<td>( - )</td>
<td>( - )</td>
<td>°C</td>
<td>With max. resolution</td>
</tr>
<tr>
<td>Sampling Rate (( T_A = +25^\circ C ))</td>
<td>( t_{CONV} )</td>
<td>( 320 )</td>
<td>( - )</td>
<td>( - )</td>
<td>ms</td>
<td>18-bit resolution</td>
</tr>
<tr>
<td></td>
<td></td>
<td>( 80 )</td>
<td>( - )</td>
<td>( - )</td>
<td>ms</td>
<td>16-bit resolution</td>
</tr>
<tr>
<td></td>
<td></td>
<td>( 20 )</td>
<td>( - )</td>
<td>( - )</td>
<td>ms</td>
<td>14-bit resolution</td>
</tr>
<tr>
<td></td>
<td></td>
<td>( 5 )</td>
<td>( - )</td>
<td>( - )</td>
<td>ms</td>
<td>12-bit resolution</td>
</tr>
<tr>
<td>Temperature Calculation Time</td>
<td>( t_{CALC} )</td>
<td>( 12 )</td>
<td>( - )</td>
<td>( - )</td>
<td>ms</td>
<td>( T_A = +25^\circ C )</td>
</tr>
</tbody>
</table>

#### Thermocouple Input

| Offset Error | \( V_{OERR} \) | \( \pm 2 \) | \( - \) | \( - \) | µV | |
| Offset Error Drift | \( V_{OERR\_DRF} \) | \( 50 \) | \( - \) | \( - \) | nV/°C | |
| Full-Scale Gain Error | \( G_{ERR} \) | \( - \) | \( - \) | \( \pm 0.04 \) | %FS | \( T_A = 0^\circ C \) to +85°C |
| Full-Scale Gain Error Drift | \( G_{ERR\_DRF} \) | \( \pm 0.01 \) | \( - \) | \( - \) | %FS | |
| Full-Scale Integral Nonlinearity | \( INL \) | \( 10 \) | \( - \) | \( - \) | ppm | |
| Voltage Resolution | \( V_{RES} \) | \( 2 \) | \( - \) | \( - \) | µV | 18-bit resolution |
| Differential Mode Range | \( V_{IN\_DF} \) | \( -250 \) | \( - \) | \( +250 \) | mV | ADC input range |
| Differential Mode Impedance | \( Z_{IN\_DF} \) | \( 300 \) | \( - \) | \( - \) | kΩ | |
| Common-Mode Range | \( V_{IN\_CM} \) | \( V_{DD} - 0.3 \) | \( - \) | \( - \) | V | \( V_{DD} + 0.3 \) (Note 4) |
| Common-Mode Impedance | \( Z_{IN\_CM} \) | \( 25 \) | \( - \) | \( - \) | MΩ | |
| Common-Mode Rejection Ratio | | | | | dB | |
| Power Supply Rejection Ratio | \( PSRR \) | \( 60 \) | \( - \) | \( - \) | dB | |
| Line Regulation | \( V_{Line\_R} \) | \( 0.2 \) | \( - \) | \( - \) | °C/V | |

#### Alert 1, 2, 3, 4 Outputs

| Low-Level Voltage | \( V_{OL} \) | \( - \) | \( - \) | \( 0.4 \) | V | \( I_{OL} = 3 \) mA |
| High-Level Voltage | \( V_{OH} \) | \( V_{DD} - 0.5 \) | \( - \) | \( - \) | V | \( I_{OH} = 3 \) mA |

#### Operating Voltage and Current

| Operating Voltage | \( V_{DD} \) | 2.7 | 5.5 | V |
| \( I^2C \) Inactive Current | \( I_D \) | 0.3 | 0.5 | mA | \( V_{DD} = 3.3 \)V, \( T_A = +85^\circ C \) |
| \( I^2C \) Active Current or During \( t_{CALC} \) | \( I_{SHDN} \) | 2 | 5 | µA | \( I^2C \) inactive, \( T_A = +85^\circ C \) |
| Power-on Reset (POR) Thresholds | \( V_{POR} \) | 1.0 | 2.1 | 2.6 | V | Rising/Falling \( V_{DD} \) |

#### Thermal Response

| 5x5 mm MQFN Package (Cold-Junction) | \( t_{RSP} \) | 3 | \( - \) | \( - \) | s | Time to 63%, +25°C (air) to +125°C (oil bath), 2x2 inch PCB |

**Note 1:** The \( T_C \) and \( T_H \) summation is implemented in milli-volt (mV) domain. The result, \( T_H \) (mV), is converted to Degree Celsius using the NIST ITS-90 Conversion database.

**Note 2:** The \( T_A\_ACV \) temperature accuracy specification is defined as the device accuracy to the NIST ITS-90 Thermocouple EMF to Degree Celsius Conversion Database. \( T_A \) is also defined as the temperature difference between the hot and cold-junctions or temperatures from the NIST ITS-90 database with \( T_C = 0^\circ C \).

**Note 3:** The device measures temperature below the specified range, however, the sensitivity to changes in temperature reduces exponentially. Type R and S measure down to -50°C, or -0.226 mV EMF and -0.235 mV EMF respectively. Type B measures down to 500°C or 1.242 mV EMF (see Figures 2-7, 2-8, 2-10, 2-11, 2-14 and 2-17).

**Note 4:** Exceeding the \( V_{IN\_CM} \) input range may cause leakage current through the ESD protection diodes at the thermocouple input pins. This parameter is characterized but not production tested.
INPUT/OUTPUT PIN DC CHARACTERISTICS

**Electrical Specifications:** Unless otherwise indicated, \( V_{DD} = 2.7 \text{V} \) to 5.5V, GND = Ground, \( T_A = -40^\circ\text{C} \) to +125°C (where: \( T_A = T_C \), defined as Device Ambient Temperature).

<table>
<thead>
<tr>
<th>Parameters</th>
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<th>Conditions</th>
</tr>
</thead>
</table>

Serial Input/Output and \( \text{I}^2\text{C} \) Slave Address Input (ADDR)

**Input (SCL, SDA)**

| High-Level Voltage | \( V_{IH} \) | 0.7 \( V_{DD} \) | — | — | V |
| Low-Level Voltage | \( V_{IL} \) | — | — | 0.3 \( V_{DD} \) | V |
| Input Current | \( I_{LEAK} \) | — | — | ±2 | \( \mu\text{A} \) |

**Output (SDA)**

| Low-Level Voltage | \( V_{OL} \) | — | — | 0.4 | V |
| High-Level Current (leakage) | \( I_{OH} \) | — | — | 1 | \( \mu\text{A} \) |
| Low-Level Current | \( I_{OL} \) | 6 | — | — | mA |
| Capacitance | \( C_{IN} \) | — | 5 | — | pF |

**\( \text{I}^2\text{C} \) Slave Address Selection Levels** (Note 1:)

<table>
<thead>
<tr>
<th>Command Byte</th>
<th>(&lt;1100\text{ 000x}&gt;)</th>
<th>( V_{ADDR} )</th>
<th>( V_{ADDR_L} ) (2:)</th>
<th>( V_{ADDR_TYP} ) (2:)</th>
<th>( V_{ADDR_H} ) (2:)</th>
<th>V</th>
<th>Address</th>
</tr>
</thead>
<tbody>
<tr>
<td>Command Byte</td>
<td>(&lt;1100\text{ 001x}&gt;)</td>
<td>( V_{HYST} )</td>
<td>—</td>
<td>0.05 ( V_{DD} )</td>
<td>—</td>
<td>V</td>
<td>( V_{DD} &gt; 2\text{V} )</td>
</tr>
</tbody>
</table>

**SDA and SCLK Inputs**

| Hysteresis | \( T_{SP} \) | — | 50 | — | ns |

**Note 1:** The ADDR pin can be tied to \( V_{DD} \) or \( V_{SS} \). For additional slave addresses, a resistive divider network can be used to set voltage levels that are rationed to \( V_{DD} \). The device supports up to 8 levels (see Section 6.3.1 “\( \text{I}^2\text{C} \) Addressing” for recommended resistor values).

**Note 2:**
\begin{align*}
V_{ADDR_{TYP}} &= \text{Address} \cdot V_{DD}/8 + V_{DD}/16, \\
V_{ADDR_L} &= V_{ADDR_{TYP}} - V_{DD}/32 \quad \text{and} \\
V_{ADDR_H} &= V_{ADDR_{TYP}} + V_{DD}/32 \quad \text{(where: Address = 1, 2, 3, 4, 5, 6).}
\end{align*}

TEMPERATURE CHARACTERISTICS

**Electrical Specifications:** Unless otherwise indicated, \( V_{DD} = 2.7 \text{V} \) to 5.5V, GND = Ground.

<table>
<thead>
<tr>
<th>Parameters</th>
<th>Sym.</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Units</th>
<th>Conditions</th>
</tr>
</thead>
</table>

**Temperature Ranges**

| Specified Temperature Range | \( T_A \) | -40 | — | +125 | °C | (Note 1:) |
| Operating Temperature Range | \( T_A \) | -40 | — | +125 | °C |
| Storage Temperature Range | \( T_A \) | -65 | — | +150 | °C |

**Thermal Package Resistances**

| Thermal Resistance, MQFN | \( \theta_{JA} \) | — | 38.8 | — | °C/W |

**Note 1:** Operation in this range must not cause \( T_J \) to exceed the Maximum Junction Temperature (+150°C).
SENSOR SERIAL INTERFACE TIMING SPECIFICATIONS

Electrical Specifications: Unless otherwise indicated, GND = Ground, TA = -40°C to +125°C, VDD = 2.7V to 5.5V and CL = 80 pF (Note 1:).

<table>
<thead>
<tr>
<th>Parameters</th>
<th>Sym.</th>
<th>Min.</th>
<th>Max.</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>2-Wire I2C Interface</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Serial Port Frequency</td>
<td>f_SCL</td>
<td>10</td>
<td>100</td>
<td>kHz</td>
</tr>
<tr>
<td>Low Clock (2:)</td>
<td>t_LOW</td>
<td>4700</td>
<td>—</td>
<td>ns</td>
</tr>
<tr>
<td>High Clock</td>
<td>t_HIGH</td>
<td>4000</td>
<td>—</td>
<td>ns</td>
</tr>
<tr>
<td>Rise Time (3:)</td>
<td>t_R</td>
<td>—</td>
<td>1000</td>
<td>ns</td>
</tr>
<tr>
<td>Fall Time (3:)</td>
<td>t_F</td>
<td>20</td>
<td>300</td>
<td>ns</td>
</tr>
<tr>
<td>Data in Setup Time (2:)</td>
<td>t_SU:DAT</td>
<td>250</td>
<td>—</td>
<td>ns</td>
</tr>
<tr>
<td>Data in Hold Time</td>
<td>t_HD:DAT</td>
<td>0</td>
<td>—</td>
<td>ns</td>
</tr>
<tr>
<td>Start Condition Setup Time</td>
<td>t_SU:STA</td>
<td>4700</td>
<td>—</td>
<td>ns</td>
</tr>
<tr>
<td>Start Condition Hold Time</td>
<td>t_HD:STA</td>
<td>4000</td>
<td>—</td>
<td>ns</td>
</tr>
<tr>
<td>Stop Condition Setup Time</td>
<td>t_SU:STO</td>
<td>4000</td>
<td>—</td>
<td>ns</td>
</tr>
<tr>
<td>Bus Idle/Free</td>
<td>t_B-FREE</td>
<td>10</td>
<td>—</td>
<td>μs</td>
</tr>
<tr>
<td>Bus Capacitive Load</td>
<td>C_b</td>
<td>—</td>
<td>400</td>
<td>pF</td>
</tr>
<tr>
<td>Clock Stretching</td>
<td>t_STRETCH</td>
<td>60</td>
<td>—</td>
<td>μs</td>
</tr>
</tbody>
</table>

Note 1: All values referred to VIL_MAX and VIH_MIN levels.
2: This device can be used in a Standard mode I2C bus system, but the requirement, t_SU:DAT ≥ 250 ns, must be met.
3: Characterized, but not production tested.

FIGURE 1-1: Timing Diagram.
2.0 TYPICAL PERFORMANCE CURVES

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore, outside the warranted range.

Note: Unless otherwise indicated, V_{DD} = 2.7V to 5.5V, GND = Ground, SDA/SCL pulled-up to V_{DD} and T_{A} = -40°C to +125°C.

FIGURE 2-1: Typical Temperature Accuracy from NIST ITS-90 Database, Type K.

FIGURE 2-2: Typical Temperature Accuracy from NIST ITS-90 Database, Type J.

FIGURE 2-3: Typical Temperature Accuracy from NIST ITS-90 Database, Type N.

FIGURE 2-4: Temperature Sensitivity with 18-Bit Resolution, Type K.

FIGURE 2-5: Temperature Sensitivity with 18-Bit Resolution, Type J.

FIGURE 2-6: Temperature Sensitivity with 18-Bit Resolution, Type N.
Note: Unless otherwise indicated, $V_{DD} = 2.7V$ to 5.5V, GND = Ground, SDA/SCL pulled-up to $V_{DD}$ and $T_A = -40°C$ to $+125°C$.

FIGURE 2-7: Typical Temperature Accuracy from NIST ITS-90 Database, Type S.

FIGURE 2-8: Typical Temperature Accuracy from NIST ITS-90 Database, Type R.

FIGURE 2-9: Typical Temperature Accuracy from NIST ITS-90 Database, Type E.

FIGURE 2-10: Temperature Sensitivity with 18-Bit Resolution, Type S.

FIGURE 2-11: Temperature Sensitivity with 18-Bit Resolution, Type R.

FIGURE 2-12: Temperature Sensitivity with 18-Bit Resolution, Type E.
Note: Unless otherwise indicated, \( V_{DD} = 2.7V \) to 5.5V, GND = Ground, SDA/SCL pulled-up to \( V_{DD} \) and \( T_A = -40°C \) to +125°C.

**FIGURE 2-13:** Typical Temperature Accuracy from NIST ITS-90 Database, Type T.

**FIGURE 2-14:** Typical Temperature Accuracy from NIST ITS-90 Database, Type B.

**FIGURE 2-15:** Input Offset Error Voltage \((V_{IN+}, V_{IN-})\).

**FIGURE 2-16:** Temperature Sensitivity with 18-Bit Resolution, Type T.

**FIGURE 2-17:** Temperature Sensitivity with 18-Bit Resolution, Type B.

**FIGURE 2-18:** Full-Scale Gain Error.
Note: Unless otherwise indicated, $V_{DD} = 2.7V$ to 5.5V, GND = Ground, SDA/SCL pulled-up to $V_{DD}$ and $T_A = -40^\circ C$ to $+125^\circ C$.

**FIGURE 2-19:** Input Noise, % of Full Scale.

**FIGURE 2-20:** Cold-Junction Sensor Temperature Accuracy.

**FIGURE 2-21:** SDA and Alert Outputs, $V_{OL}$ Across $V_{DD}$.

**FIGURE 2-22:** Integral Nonlinearity Across $V_{DD}$.

**FIGURE 2-23:** Cold-Junction Sensor Temperature Accuracy Distribution.

**FIGURE 2-24:** Alert Outputs, $V_{OH}$ Across $V_{DD}$.
Note: Unless otherwise indicated, $V_{DD} = 2.7V$ to $5.5V$, GND = Ground, SDA/SCL pulled-up to $V_{DD}$ and $T_A = -40°C$ to $+125°C$.

**FIGURE 2-25:** $\bar{I}_C$ Inactive, $I_{DD}$ Across $V_{DD}$.

**FIGURE 2-26:** $\bar{I}_C$ Active, $I_{DD}$ Across $V_{DD}$.

**FIGURE 2-27:** Shutdown Current, $I_{SHDN}$ Across $V_{DD}$.

**FIGURE 2-28:** SDA, SCL and ADDR Input Pins Leakage Current, $I_{LEAK}$ Across $V_{DD}$.

**FIGURE 2-29:** $\bar{I}_C$ Interface Clock Stretch Duration, $t_{STRETCH}$ Across $V_{DD}$.

**FIGURE 2-30:** Temperature Calculation Duration, $\Delta t_{CALC}$ Change Across $V_{DD}$.

Conditions:
- $t_{CALC} = 12ms$ (typical)
- $V_{DD} = 3.3V$
- $T_A$ = Room Temperature

- $T_A = -40°C$
- $T_A = +35°C$
- $T_A = +85°C$
- $T_A = +125°C$
3.0 PIN DESCRIPTION

The descriptions of the pins are listed in Table 3-1.

**TABLE 3-1: PIN FUNCTION TABLE**

<table>
<thead>
<tr>
<th>5x5 MQFN</th>
<th>Symbol</th>
<th>Pin Function</th>
</tr>
</thead>
<tbody>
<tr>
<td>1, 3, 5, 13, 17</td>
<td>GND</td>
<td>Electrical Ground</td>
</tr>
<tr>
<td>2</td>
<td>$V_{\text{IN}+}$</td>
<td>Thermocouple Positive Terminal Input</td>
</tr>
<tr>
<td>4</td>
<td>$V_{\text{IN}-}$</td>
<td>Thermocouple Negative Terminal Input</td>
</tr>
<tr>
<td>6, 7, 9, 10, 18</td>
<td>GND</td>
<td>Not Electrical Ground; must be tied to Ground</td>
</tr>
<tr>
<td>8</td>
<td>$V_{\text{DD}}$</td>
<td>Power</td>
</tr>
<tr>
<td>11</td>
<td>Alert 1</td>
<td>Alert Output 1</td>
</tr>
<tr>
<td>12</td>
<td>Alert 2</td>
<td>Alert Output 2</td>
</tr>
<tr>
<td>14</td>
<td>Alert 3</td>
<td>Alert Output 3</td>
</tr>
<tr>
<td>15</td>
<td>Alert 4</td>
<td>Alert Output 4</td>
</tr>
<tr>
<td>16</td>
<td>ADDR</td>
<td>$\text{i}^2\text{C}$ Save Address Selection Voltage Input</td>
</tr>
<tr>
<td>19</td>
<td>SCL</td>
<td>$\text{i}^2\text{C}$ Clock Input</td>
</tr>
<tr>
<td>20</td>
<td>SDA</td>
<td>$\text{i}^2\text{C}$ Data Input</td>
</tr>
<tr>
<td>21</td>
<td>EP</td>
<td>Exposed Thermal Pad (EP); must be connected to GND</td>
</tr>
</tbody>
</table>

3.1 Ground Pin (GND)

The GND pin is the system ground pin. Pins 1, 3, 5, 13 and 17 are system ground pins and they are at the same potential. However, pins 6, 7, 9, 10 and 18 must be connected to ground for normal operation.

3.2 Thermocouple Input ($V_{\text{IN}+}$, $V_{\text{IN}-}$)

The thermocouple wires are directly connected to these inputs. The positive node is connected to the $V_{\text{IN}+}$ pin, while the negative node connects to the $V_{\text{IN}-}$ node. The thermocouple voltage is converted to degree Celsius.

3.3 Power Pin ($V_{\text{DD}}$)

$V_{\text{DD}}$ is the power pin. The operating voltage range, as specified in the DC Characteristics table, is applied on this pin.

3.4 Push-Pull Alert Outputs (Alert 1, 2, 3, 4)

The MCP9600 device’s Alert pins are user-programmable push-pull outputs which can be used to detect rising or falling temperatures. The device outputs signal when the ambient temperature exceeds the user-programmed temperature alert limit.

3.5 $\text{i}^2\text{C}$ Slave Address Pin (ADDR)

This pin is used to set the $\text{i}^2\text{C}$ slave address. This pin can be tied to $V_{\text{DD}}$, GND, or a ratio of $V_{\text{DD}}$ can be selected to set up to eight address levels using a resistive voltage divider network.

3.6 Serial Clock Line (SCL)

The SCL is a clock input pin. All communication and timing is relative to the signal on this pin. The clock is generated by the host or master controller on the bus (see Section 4.0 “Serial Communication”).

3.7 Serial Data Line (SDA)

SDA is a bidirectional input/output pin used to serially transmit data to/from the host controller. This pin requires a pull-up resistor (see Section 4.0 “Serial Communication”).
4.0 SERIAL COMMUNICATION

4.1 2-Wire Standard Mode \( \text{I}^2\text{C} \) Protocol-Compatible Interface

The MCP9600 device’s Serial Clock Input (SCL) and the bidirectional Serial Data Line (SDA) form a 2-wire bidirectional data communication line (refer to the Input/Output Pin DC Characteristics table and Sensor Serial Interface Timing Specifications table).

The following bus protocol has been defined:

**TABLE 4-1: MCP9600 SERIAL BUS PROTOCOL DESCRIPTIONS**

<table>
<thead>
<tr>
<th>Term</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>Master</td>
<td>The device that controls the serial bus, typically a microcontroller.</td>
</tr>
<tr>
<td>Slave</td>
<td>The device addressed by the master, such as the MCP9600.</td>
</tr>
<tr>
<td>Transmitter</td>
<td>Device sending data to the bus.</td>
</tr>
<tr>
<td>Receiver</td>
<td>Device receiving data from the bus.</td>
</tr>
<tr>
<td>START</td>
<td>A unique signal from master to initiate serial interface with a slave.</td>
</tr>
<tr>
<td>STOP</td>
<td>A unique signal from the master to terminate serial interface from a slave.</td>
</tr>
<tr>
<td>Read/Write</td>
<td>A read or write to the MCP9600 registers.</td>
</tr>
<tr>
<td>ACK</td>
<td>A receiver Acknowledges (ACK) the reception of each byte by polling the bus.</td>
</tr>
<tr>
<td>NAK</td>
<td>A receiver Not Acknowledges (NAK) or releases the bus to show End-of-Data (EOD).</td>
</tr>
<tr>
<td>Busy</td>
<td>Communication is not possible because the bus is in use.</td>
</tr>
<tr>
<td>Not Busy</td>
<td>The bus is in the Idle state, both SDA and SCL remain high.</td>
</tr>
<tr>
<td>Data Valid</td>
<td>SDA must remain stable before SCL becomes high in order for a data bit to be considered valid. During normal data transfers, SDA only changes state while SCL is low.</td>
</tr>
</tbody>
</table>

4.1.1 DATA TRANSFER

Data transfers are initiated by a Start condition (START), followed by a 7-bit device address and a read/write bit. An Acknowledge (ACK) from the slave confirms the reception of each byte. Each access must be terminated by a Stop condition (STOP).

Repeated communication is initiated after \( t_{B-FREE} \).

This device supports the Receive Protocol. The register can be specified using the pointer for the initial read. Each repeated read or receive begins with a Start condition and address byte. The MCP9600 retains the previously selected register. Therefore, it outputs data from the previously-specified register (repeated pointer specification is not necessary).

4.1.2 MASTER/SLAVE

The bus is controlled by a master device (typically a microcontroller) that controls the bus access, and generates the Start and Stop conditions. The MCP9600 is a slave device and does not control other devices in the bus. Both master and slave devices can operate as either transmitter or receiver. However, the master device determines which mode is activated.

4.1.3 START/STOP CONDITION

A high-to-low transition of the SDA line (while SCL is high) is the Start condition. All data transfers must be preceded by a Start condition from the master. A low-to-high transition of the SDA line (while SCL is high) signifies a Stop condition.

If a Start or Stop condition is introduced during data transmission, the MCP9600 releases the bus. All data transfers are ended by a Stop condition from the master.

4.1.4 ADDRESS BYTE

Following the Start condition, the host must transmit an 8-bit address byte to the MCP9600. The address for the MCP9600 temperature sensor is ‘11, 0, 0, A2, A1, A0’ in binary, where the A2, A1 and A0 bits are set externally by connecting the corresponding VADDR voltage levels on the ADDR pin (see the “Input/Output Pin DC Characteristics” section). The 7-bit address transmitted in the serial bit stream must match the selected address for the MCP9600 to respond with an ACK. Bit 8 in the address byte is a read/write bit. Setting this bit to ‘1’ commands a read operation, while ‘0’ commands a write operation (see Figure 4-1).

**FIGURE 4-1: Device Addressing.**
4.1.5 DATA VALID

After the Start condition, each bit of data in transmission needs to be settled for a time specified by \( t_{SU-DATA} \) before SCL toggles from low-to-high (see the “Sensor Serial Interface Timing Specifications” section).

4.1.6 ACKNOWLEDGE (ACK/NAK)

Each receiving device, when addressed, is expected to generate an ACK bit after the reception of each byte. The master device must generate an extra clock pulse for ACK to be recognized.

The Acknowledging device pulls down the SDA line for \( t_{SU-DATA} \) before the low-to-high transition of SCL from the master. SDA also needs to remain pulled down for \( t_{HD-DAT} \) after a high-to-low transition of SCL.

During read, the master must signal an End-of-Data (EOD) to the slave by not generating an ACK bit (NAK) once the last bit has been clocked out of the slave. In this case, the slave will leave the data line released to enable the master to generate the Stop condition.

4.1.7 CLOCK STRETCHING

During the \( I^2C \) read operation, this device will hold the \( I^2C \) clock line low for \( t_{STRETCH} \) after the falling edge of the ACK signal. In order to prevent bus contention, the master controller must release or hold the SCL line low during this period.

In addition, the master controller must provide eight consecutive clock cycles after generating the ACK bit from a read command. This allows the device to push out data from the SDA Output Shift registers. Missing clock cycles could result in bus contention. At the end of the data transmission, the master controller must provide the NAK bit, followed by a Stop bit to terminate communication.

![Clock Stretching](image)

**FIGURE 4-2:** Clock Stretching.

4.1.8 SEQUENTIAL READ

During a sequential read, the device transmits data from the proceeding register, starting from the previously set Register Pointer. The MCP9600 maintains an Internal Address Pointer, which is incremented at the completion of each read data transmission, followed by an ACK from the master. A Stop bit terminates the sequential read.
FIGURE 4-3: Timing Diagram to Set a Register Pointer and Read a Two-Byte Data.

Note: this is an example pseudo routine:

```c
i2c_start(); // send START command
i2c_write(b'1100 0000'); // WRITE Command
i2c_write(b'0000 00XX'); // also, make sure bit 0 is cleared '0'
// Write TH, TA, or TC registers
i2c_stop(); // send STOP command
i2c_start(); // send START command
i2c_write(b'1100 0001'); // READ Command
// also, make sure bit 0 is set '1'
UpperByte = i2c_read(ACK); // READ 8 bits
// and Send ACK bit
LowerByte = i2c_read(NAK); // READ 8 bits
// and Send NAK bit
i2c_stop(); // send STOP command

//Convert the temperature data
if ((UpperByte & 0x80) == 0x80){ //TA < 0°C
    Temperature = (UpperByte x 16 + LowerByte / 16) - 4096;
}else //TA ≥ 0°C
    Temperature = (UpperByte x 16 + LowerByte / 16);
//Temperature = Ambient Temperature (°C)
```
FIGURE 4-4: Timing Diagram to Set a Register Pointer and Read a Two-Byte Data.

Note: this is an example pseudo routine:

```python
cdef _start():
    # send START command
    i2c_start();

cdef _write(b’1100 0000’):
    # WRITE Command
    i2c_write(b’1100 0000’);
    # also, make sure bit 0 is cleared '0'
    i2c_write(b’0000 01XX’);
    # Write Status or Configuration registers
    i2c_write(b’XXXX XXXX’);
    # Write register data
    i2c_stop();

cdef _start():
    # send STOP command
    i2c_start();

cdef _write(b’1100 0001’):
    # READ Command
    i2c_write(b’1100 0001’);
    # also, make sure bit 0 is set '1'
    Data = i2c_read(NAK);
    # READ 8 bits
    # and Send NAK bit
    i2c_stop();
    # send STOP command
```
FIGURE 4-5: Timing Diagram to Set a Register Pointer and Read a Two-Byte Data.

### TABLE 4-4: POINTERS

<table>
<thead>
<tr>
<th>Alert Limit Registers</th>
<th>Pointer</th>
</tr>
</thead>
<tbody>
<tr>
<td>Alert 1</td>
<td>0001 0000</td>
</tr>
<tr>
<td>Alert 2</td>
<td>0001 0001</td>
</tr>
<tr>
<td>Alert 3</td>
<td>0001 0010</td>
</tr>
<tr>
<td>Alert 4</td>
<td>0001 0011</td>
</tr>
</tbody>
</table>

**Note:** this is an example pseudo routine:

```python
i2c_start();  # send START command
i2c_write(b'1100 0000');  # WRITE Command
# also, make sure bit 0 is cleared '0'
i2c_write(b'0001 00XX');  # Write Alert registers
i2c_write(b'XXXX XXXX');  # Write register Upper Byte
i2c_write(b'XXXX XXXX');  # Write register Lower Byte
i2c_stop();  # send STOP command
i2c_start();  # send START command
i2c_write(b'1100 0001');  # READ Command
# also, make sure bit 0 is set '1'
UpperByte = i2c_read(ACK);  # READ 8 bits
# and Send ACK bit
LowerByte = i2c_read(NAK);  # READ 8 bits
# and Send NAK bit
i2c_stop();  # send STOP command
```
FIGURE 4-6: Timing Diagram to Sequential Read All Registers Starting from $T_H$ Register.

**Note 1:** All registers can be read sequentially starting from the previously set Register Pointer.

**Note:** this is an example pseudo routine:

```c
i2c_start(); // send START command
i2c_write(b’1100 0000’); // WRITE Command
    // also, make sure bit 0 is cleared '0'
i2c_write(b’0000 0000’); // Write $T_H$ register to set the starting register for sequential read
i2c_stop(); // send STOP command
i2c_start(); // send START command
i2c_write(b’1100 0001’); // READ Command
    // also, make sure bit 0 is set '1'
for (i=0; i<29, i++){
    Data_Buffer[i] = i2c_read(ACK); // READ 8 bits
        // and Send ACK bit
}
Data_Buffer[29] = i2c_read(NAK); // READ 8 bits
    // and Send NAK bit
i2c_stop(); // send STOP command
```
5.0 FUNCTIONAL DESCRIPTION

The MCP9600 temperature sensor consists of an 18-bit Delta-Sigma Analog-to-Digital Converter (ADC), which is used to measure the thermocouple voltage or EMF, a digital temperature sensor used to measure cold-junction or ambient temperature and a processor core which is used to compute the EMF to degree Celsius conversion using coefficients derived from the NIST ITS-90 coefficients. Figure 5-1 shows a block diagram of how these functions are structured in the device.

FIGURE 5-1: Functional Block Diagram.
The MCP9600 device has several registers that are user-accessible. These registers include the Thermocouple Temperature (cold-junction compensated), Hot-Junction Temperature, Cold-Junction Temperature, Raw ADC Data, user-programmable Alert Limit registers, and STATUS and Configuration registers.

The Temperature and the Raw ADC Data registers are read-only registers, used to access the thermocouple and the ambient temperature data. In addition, the four Alert Temperature registers are individually controlled, and can be used to detect a rising and/or a falling temperature change. If the ambient temperature drifts beyond the user-specified limits, the MCP9600 device outputs an alert flag at the corresponding pin (refer to Section 5.3.3 “Alert Configuration Registers”). The alert limits can also be used to detect critical temperature events.

**REGISTER 5-1: REGISTER POINTER**

<table>
<thead>
<tr>
<th>U-0</th>
<th>U-0</th>
<th>U-0</th>
<th>U-0</th>
<th>W-0</th>
<th>W-0</th>
<th>W-0</th>
<th>W-0</th>
</tr>
</thead>
<tbody>
<tr>
<td>—</td>
<td>—</td>
<td>—</td>
<td>—</td>
<td>P&lt;3:0&gt;</td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

bit 7 | bit 0

Legend:
R = Readable bit  W = Writable bit  U = Unimplemented bit, read as ‘0’
-n = Value at POR  ‘1’ = Bit is set  ‘0’ = Bit is cleared  x = Bit is unknown

bit 7-4  Unimplemented: Read as ‘0’
bit 3-0  **P<3:0>:** Pointer bits
0000 0000 = Thermocouple Hot-Junction register, TH
0000 0001 = Junctions Temperature Delta register, TΔ
0000 0010 = Cold-Junction Temperature register, TC
0000 0011 = Raw ADC Data register
0000 0100 = STATUS register
0000 0101 = Thermocouple Sensor Configuration register
0000 0110 = Device Configuration register
0000 1000 = Alert 1 Configuration register
0000 1001 = Alert 2 Configuration register
0000 1010 = Alert 3 Configuration register
0000 1011 = Alert 4 Configuration register
0000 1100 = Alert 1 Hysteresis register, THYST1
0000 1101 = Alert 2 Hysteresis register, THYST2
0000 1110 = Alert 3 Hysteresis register, THYST3
0000 1111 = Alert 4 Hysteresis register, THYST4
0001 0000 = Temperature Alert 1 Limit register, TALER1
0001 0001 = Temperature Alert 2 Limit register, TALER2
0001 0010 = Temperature Alert 3 Limit register, TALER3
0001 0011 = Temperature Alert 4 Limit register, TALER4
0010 0000 = Device ID/Revision register

The MCP9600 also provides STATUS and Configuration registers, which allow users to detect device statuses. The Configuration registers provide various features, such as adjustable temperature measurement resolution and Shutdown modes. The thermocouple types can also be selected using the Configuration registers.

The registers are accessed by sending a Register Pointer to the MCP9600 using the serial interface. This is an 8-bit write-only pointer. **Register 5-1** describes the pointer definitions.
Table 5-1: Summary of Registers and Bit Assignments

<table>
<thead>
<tr>
<th>Register Description</th>
<th>Pointer</th>
<th>bit 7</th>
<th>bit 6</th>
<th>bit 5</th>
<th>bit 4</th>
<th>bit 3</th>
<th>bit 2</th>
<th>bit 1</th>
<th>bit 0</th>
</tr>
</thead>
<tbody>
<tr>
<td>Hot-Junction Temperature – ( T_H )</td>
<td>00000000</td>
<td>SIGN</td>
<td>1024°C</td>
<td>512°C</td>
<td>256°C</td>
<td>128°C</td>
<td>64°C</td>
<td>32°C</td>
<td>16°C</td>
</tr>
<tr>
<td></td>
<td></td>
<td>8°C</td>
<td>4°C</td>
<td>2°C</td>
<td>1°C</td>
<td>0.5°C</td>
<td>0.25°C</td>
<td>0.125°C</td>
<td>0.0625°C</td>
</tr>
<tr>
<td>Junctions Temperature Delta – ( \Delta T )</td>
<td>00000001</td>
<td>SIGN</td>
<td>1024°C</td>
<td>512°C</td>
<td>256°C</td>
<td>128°C</td>
<td>64°C</td>
<td>32°C</td>
<td>16°C</td>
</tr>
<tr>
<td></td>
<td></td>
<td>8°C</td>
<td>4°C</td>
<td>2°C</td>
<td>1°C</td>
<td>0.5°C</td>
<td>0.25°C</td>
<td>0.125°C</td>
<td>0.0625°C</td>
</tr>
<tr>
<td>Cold-Junction Temperature – ( T_C )</td>
<td>00000010</td>
<td>SIGN</td>
<td>128°C</td>
<td>64°C</td>
<td>32°C</td>
<td>16°C</td>
<td>8°C</td>
<td>4°C</td>
<td>2°C</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>1°C</td>
<td>0.5°C</td>
<td>0.25°C</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>0.125°C</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>0.0625°C</td>
</tr>
<tr>
<td>Raw Data ADC</td>
<td>00000011</td>
<td>SIGN</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>bit 17</td>
<td>bit 16</td>
<td>bit 8</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>bit 15</td>
<td>—</td>
<td>—</td>
<td>—</td>
<td>—</td>
<td>—</td>
<td>—</td>
<td>—</td>
</tr>
<tr>
<td></td>
<td></td>
<td>bit 7</td>
<td>—</td>
<td>—</td>
<td>—</td>
<td>—</td>
<td>—</td>
<td>—</td>
<td>—</td>
</tr>
<tr>
<td></td>
<td></td>
<td>bit 0</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>STATUS</td>
<td>00000100</td>
<td>Flag, Burst Complete</td>
<td>Flag, ( T_H ) Updated</td>
<td>—</td>
<td>Flag, Input Range</td>
<td>Alert 4 Status</td>
<td>Alert 3 Status</td>
<td>Alert 2 Status</td>
<td>Alert 1 Status</td>
</tr>
<tr>
<td>Thermocouple Sensor Configuration</td>
<td>00000110</td>
<td>Cold-Junction Resolution</td>
<td>ADC Resolution</td>
<td>Burst Mode Temperature Samples</td>
<td>Shutdown Modes</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Alert 1 Configuration</td>
<td>00001000</td>
<td>Interrupt Clear</td>
<td>—</td>
<td>Monitor ( T_H ) or ( T_C )</td>
<td>Detect Rising or Falling temps</td>
<td>Active-High or Active-Low Output</td>
<td>Comparator or Interrupt Mode</td>
<td>Enable Alert Output</td>
<td></td>
</tr>
<tr>
<td>Alert 2 Configuration</td>
<td>00001010</td>
<td>—</td>
<td>—</td>
<td>—</td>
<td>—</td>
<td>—</td>
<td>—</td>
<td>—</td>
<td>—</td>
</tr>
<tr>
<td>Alert 3 Configuration</td>
<td>00001100</td>
<td>128°C</td>
<td>64°C</td>
<td>32°C</td>
<td>16°C</td>
<td>8°C</td>
<td>4°C</td>
<td>2°C</td>
<td>1°C</td>
</tr>
<tr>
<td>Alert 4 Configuration</td>
<td>00001110</td>
<td>128°C</td>
<td>64°C</td>
<td>32°C</td>
<td>16°C</td>
<td>8°C</td>
<td>4°C</td>
<td>2°C</td>
<td>1°C</td>
</tr>
<tr>
<td>Alert 1 Hysteresis</td>
<td>00010000</td>
<td>SIGN</td>
<td>1024°C</td>
<td>512°C</td>
<td>256°C</td>
<td>128°C</td>
<td>64°C</td>
<td>32°C</td>
<td>16°C</td>
</tr>
<tr>
<td></td>
<td></td>
<td>8°C</td>
<td>4°C</td>
<td>2°C</td>
<td>1°C</td>
<td>0.5°C</td>
<td>0.25°C</td>
<td>0.125°C</td>
<td>0.0625°C</td>
</tr>
<tr>
<td>Alert 2 Hysteresis</td>
<td>00010010</td>
<td>SIGN</td>
<td>1024°C</td>
<td>512°C</td>
<td>256°C</td>
<td>128°C</td>
<td>64°C</td>
<td>32°C</td>
<td>16°C</td>
</tr>
<tr>
<td></td>
<td></td>
<td>8°C</td>
<td>4°C</td>
<td>2°C</td>
<td>1°C</td>
<td>0.5°C</td>
<td>0.25°C</td>
<td>0.125°C</td>
<td>0.0625°C</td>
</tr>
<tr>
<td>Alert 3 Hysteresis</td>
<td>00010001</td>
<td>SIGN</td>
<td>1024°C</td>
<td>512°C</td>
<td>256°C</td>
<td>128°C</td>
<td>64°C</td>
<td>32°C</td>
<td>16°C</td>
</tr>
<tr>
<td></td>
<td></td>
<td>8°C</td>
<td>4°C</td>
<td>2°C</td>
<td>1°C</td>
<td>0.5°C</td>
<td>0.25°C</td>
<td>0.125°C</td>
<td>0.0625°C</td>
</tr>
<tr>
<td>Alert 4 Hysteresis</td>
<td>00010011</td>
<td>SIGN</td>
<td>1024°C</td>
<td>512°C</td>
<td>256°C</td>
<td>128°C</td>
<td>64°C</td>
<td>32°C</td>
<td>16°C</td>
</tr>
<tr>
<td></td>
<td></td>
<td>8°C</td>
<td>4°C</td>
<td>2°C</td>
<td>1°C</td>
<td>0.5°C</td>
<td>0.25°C</td>
<td>0.125°C</td>
<td>0.0625°C</td>
</tr>
<tr>
<td>Device ID/Revision</td>
<td>00100000</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>Revision ID Major</td>
<td>Revision ID Minor</td>
<td>—</td>
<td>—</td>
<td>—</td>
<td>—</td>
<td>—</td>
<td>—</td>
</tr>
</tbody>
</table>

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5.1 Thermocouple Temperature Sensor Registers

This device integrates three Temperature registers that are used to read the cold and hot-junction temperatures, and the sum of the two junctions to output the absolute thermocouple temperature. In addition, the Raw ADC Data register, which is used to derive the thermocouple temperature, is available. The following sections describe each register in detail.

5.1.1 THERMOCOUPLE TEMPERATURE REGISTER (TH)

This register contains the cold-junction compensated and error-corrected thermocouple temperature in degree Celsius. The temperature data from this register is the absolute Thermocouple Hot-Junction temperature, \( T_H \), to the specified accuracy (see Section 1.0 “Electrical Characteristics”). \( T_H \) is the sum of the values in the \( T_\Delta \) and \( T_C \) registers, as shown in Figure 5-2.

**EQUATION 5-1: TEMPERATURE CONVERSION**

- Temperature \( \geq 0°C \)
  \[
  T_H = (\text{UpperByte} \times 16 + \text{LowerByte}/16)
  \]
- Temperature \( < 0°C \)
  \[
  T_H = (\text{UpperByte} \times 16 + \text{LowerByte}/16) - 4096
  \]

**REGISTER 5-2: THERMOCOUPLE TEMPERATURE REGISTER (READ-ONLY)**

<table>
<thead>
<tr>
<th>SIGN</th>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
</tr>
</thead>
<tbody>
<tr>
<td>bit 15</td>
<td>1024°C</td>
<td>512°C</td>
<td>256°C</td>
<td>128°C</td>
<td>64°C</td>
<td>32°C</td>
<td>16°C</td>
<td></td>
</tr>
<tr>
<td>bit 7</td>
<td>8°C</td>
<td>4°C</td>
<td>2°C</td>
<td>1°C</td>
<td>0.5°C</td>
<td>0.25°C</td>
<td>0.125°C</td>
<td>0.0625°C</td>
</tr>
<tr>
<td>bit 0</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

Legend:
- \( R = \) Readable bit
- \( W = \) Writable bit
- \( U = \) Unimplemented bit, read as ‘0’
- \( -n = \) Value at POR
- ‘1’ = Bit is set
- ‘0’ = Bit is cleared
- \( x = \) Bit is unknown

bit 15 \( \text{SIGN: Sign bit} \)
- \( 1 = T_A < 0°C \)
- \( 0 = T_A \geq 0°C \)

bit 14-0 \( \text{TH: Data in Two’s Complement Format bits} \)
This register contains the error corrected and cold-junction compensated thermocouple temperature.
5.1.2 THERMOCOUPLE JUNCTIONS
DELTA TEMPERATURE
REGISTER (T\(\Delta\))

This register contains the error corrected Thermocouple Hot-Junction temperature without the Cold-Junction compensation. The error correction methodology uses several coefficients to convert the digitized Thermocouple EMF voltage to degree Celsius. Each Thermocouple type has a unique set of coefficients as specified by NIST, and these coefficients are available in the configuration register for user selection as shown in Figure 5-3.

**EQUATION 5-2: TEMPERATURE CONVERSION**

Temperature \(\geq 0^\circ C\)
\[ T_{\Delta} = (\text{UpperByte} \times 16 + \text{LowerByte} / 16) \]

Temperature \(< 0^\circ C\)
\[ T_{\Delta} = (\text{UpperByte} \times 16 + \text{LowerByte} / 16) - 4096 \]

**FIGURE 5-3:** Thermocouple Hot-Junction Register (T\(\Delta\)) Block Diagram.

**REGISTER 5-3: HOT-JUNCTION TEMPERATURE REGISTER (READ-ONLY)**

<table>
<thead>
<tr>
<th>bit 15</th>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
</tr>
</thead>
<tbody>
<tr>
<td>SIGN</td>
<td>1024°C</td>
<td>512°C</td>
<td>256°C</td>
<td>128°C</td>
<td>64°C</td>
<td>32°C</td>
<td>16°C</td>
<td></td>
</tr>
<tr>
<td>bit 14-0</td>
<td>R-0</td>
<td>R-0</td>
<td>R-0</td>
<td>R-0</td>
<td>R-0</td>
<td>R-0</td>
<td>R-0</td>
<td>R-0</td>
</tr>
<tr>
<td>8°C</td>
<td>4°C</td>
<td>2°C</td>
<td>1°C</td>
<td>0.5°C</td>
<td>0.25°C</td>
<td>0.125°C</td>
<td>0.0625°C</td>
<td></td>
</tr>
</tbody>
</table>

**Legend:**

- R = Readable bit
- W = Writable bit
- U = Unimplemented bit, read as '0'
- -n = Value at POR
  - ‘1’ = Bit is set
  - ‘0’ = Bit is cleared
  - x = Bit is unknown

- bit 15 \(\text{SIGN}: \) Sign bit
  - 1 = \(T_{\Delta} < 0^\circ C\)
  - 0 = \(T_{\Delta} \geq 0^\circ C\)

- bit 14-0 \(T_{\Delta}: \) Data in Two’s Complement Format bits
  This register contains Thermocouple Hot-Junction temperature data.
5.1.3 COLD-JUNCTION/AMBIENT TEMPERATURE REGISTER (T_C)

The MCP9600 integrates an ambient temperature sensor which can be used to measure the thermocouple cold-junction temperature. For accurate measurement, the MCP9600 will have to be placed at close proximity to the thermocouple cold-junction to detect the junction ambient temperature. This is a 16-bit double-buffered, read-only register. The temperature resolution is user-selectable to 0.0625°C/LSb or 0.25°C/LSb resolutions and setting the resolution determines the temperature update rate, as shown in Table 5-2.

**EQUATION 5-3: TEMPERATURE CONVERSION**

Temperature ≥ 0°C
\[ T_C = (\text{UpperByte} \times 16 + \frac{\text{LowerByte}}{16}) \]

Temperature < 0°C
\[ T_C = (\text{UpperByte} \times 16 + \frac{\text{LowerByte}}{16}) - 4096 \]

The temperature bits are in two's complement format; therefore, positive temperature data and negative temperature data are computed differently, as shown in Equation 5-3.

**REGISTER 5-4: COLD-JUNCTION TEMPERATURE REGISTER**

<table>
<thead>
<tr>
<th>Bit 15-12</th>
<th>SIGN</th>
<th>128°C</th>
<th>64°C</th>
<th>32°C</th>
<th>16°C</th>
</tr>
</thead>
<tbody>
<tr>
<td>Bit 7-0</td>
<td>8°C</td>
<td>4°C</td>
<td>2°C</td>
<td>1°C</td>
<td>0.5°C</td>
</tr>
<tr>
<td></td>
<td>0.25°C</td>
<td>0.125°C</td>
<td>0.0625°C</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

**Legend:**
- R = Readable bit
- W = Writable bit
- U = Unimplemented bit, read as ‘0’
- -n = Value at POR
- ’1’ = Bit is set
- ’0’ = Bit is cleared
- x = Bit is unknown

**TABLE 5-2: RESOLUTION vs. CONVERSION TIME**

| Resolution | Conversion Time (typical) | Register Bits (Note 1:)
<table>
<thead>
<tr>
<th></th>
<th></th>
<th></th>
</tr>
</thead>
<tbody>
<tr>
<td>0.0625°C</td>
<td>250 ms</td>
<td>ssss xxxx xxxx xxxx</td>
</tr>
<tr>
<td>0.25°C</td>
<td>63 ms</td>
<td>ssss xxxx xxxx xx00</td>
</tr>
</tbody>
</table>

Note 1: ‘s’ is Sign and ‘x’ is unknown bit.

**FIGURE 5-4: Thermocouple Cold-Junction Register (T_C) Block Diagram.**

**TABLE 5-2: RESOLUTION vs. CONVERSION TIME**

| Resolution | Conversion Time (typical) | Register Bits (Note 1:)
<table>
<thead>
<tr>
<th></th>
<th></th>
<th></th>
</tr>
</thead>
<tbody>
<tr>
<td>0.0625°C</td>
<td>250 ms</td>
<td>ssss xxxx xxxx xxxx</td>
</tr>
<tr>
<td>0.25°C</td>
<td>63 ms</td>
<td>ssss xxxx xxxx xx00</td>
</tr>
</tbody>
</table>

Note 1: ‘s’ is Sign and ‘x’ is unknown bit.

**FIGURE 5-4: Thermocouple Cold-Junction Register (T_C) Block Diagram.**

**REGISTER 5-4: COLD-JUNCTION TEMPERATURE REGISTER**

<table>
<thead>
<tr>
<th>Bit 15-12</th>
<th>SIGN</th>
<th>128°C</th>
<th>64°C</th>
<th>32°C</th>
<th>16°C</th>
</tr>
</thead>
<tbody>
<tr>
<td>Bit 7-0</td>
<td>8°C</td>
<td>4°C</td>
<td>2°C</td>
<td>1°C</td>
<td>0.5°C</td>
</tr>
<tr>
<td></td>
<td>0.25°C</td>
<td>0.125°C</td>
<td>0.0625°C</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

**Legend:**
- R = Readable bit
- W = Writable bit
- U = Unimplemented bit, read as ‘0’
- -n = Value at POR
- ’1’ = Bit is set
- ’0’ = Bit is cleared
- x = Bit is unknown

**TABLE 5-2: RESOLUTION vs. CONVERSION TIME**

| Resolution | Conversion Time (typical) | Register Bits (Note 1:)
<table>
<thead>
<tr>
<th></th>
<th></th>
<th></th>
</tr>
</thead>
<tbody>
<tr>
<td>0.0625°C</td>
<td>250 ms</td>
<td>ssss xxxx xxxx xxxx</td>
</tr>
<tr>
<td>0.25°C</td>
<td>63 ms</td>
<td>ssss xxxx xxxx xx00</td>
</tr>
</tbody>
</table>

Note 1: ‘s’ is Sign and ‘x’ is unknown bit.

**FIGURE 5-4: Thermocouple Cold-Junction Register (T_C) Block Diagram.**

**REGISTER 5-4: COLD-JUNCTION TEMPERATURE REGISTER**

<table>
<thead>
<tr>
<th>Bit 15-12</th>
<th>SIGN</th>
<th>128°C</th>
<th>64°C</th>
<th>32°C</th>
<th>16°C</th>
</tr>
</thead>
<tbody>
<tr>
<td>Bit 7-0</td>
<td>8°C</td>
<td>4°C</td>
<td>2°C</td>
<td>1°C</td>
<td>0.5°C</td>
</tr>
<tr>
<td></td>
<td>0.25°C</td>
<td>0.125°C</td>
<td>0.0625°C</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

**Legend:**
- R = Readable bit
- W = Writable bit
- U = Unimplemented bit, read as ‘0’
- -n = Value at POR
- ’1’ = Bit is set
- ’0’ = Bit is cleared
- x = Bit is unknown

**TABLE 5-2: RESOLUTION vs. CONVERSION TIME**

| Resolution | Conversion Time (typical) | Register Bits (Note 1:)
<table>
<thead>
<tr>
<th></th>
<th></th>
<th></th>
</tr>
</thead>
<tbody>
<tr>
<td>0.0625°C</td>
<td>250 ms</td>
<td>ssss xxxx xxxx xxxx</td>
</tr>
<tr>
<td>0.25°C</td>
<td>63 ms</td>
<td>ssss xxxx xxxx xx00</td>
</tr>
</tbody>
</table>

Note 1: ‘s’ is Sign and ‘x’ is unknown bit.

**FIGURE 5-4: Thermocouple Cold-Junction Register (T_C) Block Diagram.**
5.1.4 ANALOG-TO-DIGITAL CONVERTER (ADC)

The MCP9600 uses an 18-bit Delta-Sigma Analog-to-Digital Converter to digitize the Thermocouple EMF voltage and the data is available in the ADC register. The ADC measurement resolution is selectable, which enables the user to choose faster conversion times with reduced resolution. This feature is useful to detect fast transient temperatures.

**TABLE 5-3: ADC RESOLUTION**

<table>
<thead>
<tr>
<th>Resolution/Sensitivity (typical)</th>
<th>Conversion Time (typical)</th>
<th>Raw ADC Register Bit Format (Note 1)</th>
</tr>
</thead>
<tbody>
<tr>
<td>18 bit/2 μV</td>
<td>320 ms</td>
<td>ssss ssss xxxx xxxx xxxx</td>
</tr>
<tr>
<td>16 bit/8 μV</td>
<td>80 ms</td>
<td>ssss ssss xxxx xxxx xxx00</td>
</tr>
<tr>
<td>14 bit/32 μV</td>
<td>20 ms</td>
<td>ssss ssss xxxx xxx000 0000</td>
</tr>
<tr>
<td>12 bit/128 μV</td>
<td>5 ms</td>
<td>ssss ssss xxxx 0000 0000</td>
</tr>
</tbody>
</table>

Note 1: ‘s’ is the Sign bit and ‘x’ is the ADC data bit.

2: See Section 6.2.2 “Conversion Time vs. Self-Heat”.

**REGISTER 5-5: ADC SAMPLE: 24-BIT REGISTER**

<table>
<thead>
<tr>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
</tr>
</thead>
<tbody>
<tr>
<td>SIGN</td>
<td>ADC Data</td>
<td>bit 23</td>
<td>bit 16</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

| R-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 |
|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| ADC Data | bit 15 | bit 8 |

| R-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 |
|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| ADC Data | bit 7 | bit 0 |

**Legend:**

- R = Readable bit
- W = Writable bit
- U = Unimplemented bit, read as ‘0’
- -n = Value at POR
- ‘1’ = Bit is set
- ‘0’ = Bit is cleared
- x = Bit is unknown

bit 23-0 **ADC Data<23:0>:** Raw ADC Data bits

Includes sign bits.
5.2 Sensor STATUS and Configuration Registers

This device provides various temperature and measurement Status bits which can be monitored regularly by the master controller. In addition, this device integrates various user-programmable features which can be useful to develop complex thermal management applications. The following sections describe each feature in detail.

5.2.1 STATUS REGISTER

The STATUS register contains several flag bits that indicate statuses, such as temperature alert, the ADC input range status for the selected thermocouple type and the Temperature register update status for both single conversion or Burst mode conversions.

<table>
<thead>
<tr>
<th>Bit</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>7</td>
<td>Burst Complete: Burst Mode Conversions Status Flag bit</td>
</tr>
<tr>
<td>6</td>
<td>TH Update: Temperature Update Flag bit</td>
</tr>
<tr>
<td>5</td>
<td>Unimplemented: Read as ‘0’.</td>
</tr>
<tr>
<td>4</td>
<td>Input Range: Temperature Range Detection bit (read-only)</td>
</tr>
<tr>
<td>3</td>
<td>Alert 4: Status bit (read-only)</td>
</tr>
<tr>
<td>2</td>
<td>Alert 3: Status bit (read-only)</td>
</tr>
<tr>
<td>1</td>
<td>Alert 2: Status bit (read-only)</td>
</tr>
<tr>
<td>0</td>
<td>Alert 1: Status bit (read-only)</td>
</tr>
</tbody>
</table>

Legend:
- R = Readable bit
- W = Writable bit
- U = Unimplemented bit, read as ‘0’
- = Value at POR
- Value at POR

- 0 = Bit is cleared
- x = Bit is unknown

bit 7
- Burst Complete: Burst Mode Conversions Status Flag bit
- 1 = TH register Burst mode conversions complete
- 0 = Writing ‘0’ has no effect

Once Burst mode is enabled, this bit is normally set after the first burst is complete. User can clear it and poll the bit periodically until the next burst of temperature conversions is complete (see Register 5-8).

bit 6
- TH Update: Temperature Update Flag bit
- 1 = Temperature conversion complete
- 0 = Writing ‘0’ has no effect

This bit is normally set. User can clear it and poll the bit until the next temperature conversion is complete.

bit 5
- Unimplemented: Read as ‘0’.

bit 4
- Input Range: Temperature Range Detection bit (read-only)
- 1 = The ADC input Voltage (EMF) or the temperature data from the TH register exceeds the measurement range for the selected thermocouple type
- 0 = The ADC input Voltage (EMF) or the temperature data from the TH register is within the measurement range for the selected thermocouple type

If this bit is set, then the MCP9600 does not convert the input voltage (EMF) to Degree Celsius (temperature data conversion is bypassed). The TA, TH and TC registers hold the previous temperature data.

bit 3
- Alert 4: Status bit (read-only)
- 1 = TX > T_ALERT4
- 0 = TX ≤ T_ALERT4

Where: TX is either TH or TC (user-selectable, see Register 5-10).

bit 2
- Alert 3: Status bit (read-only)
- 1 = TX > T_ALERT3
- 0 = TX ≤ T_ALERT3

Where: TX is either TH or TC (user-selectable, see Register 5-10).

bit 1
- Alert 2: Status bit (read-only)
- 1 = TX > T_ALERT2
- 0 = TX ≤ T_ALERT2

Where: TX is either TH or TC (user-selectable, see Register 5-10).

bit 0
- Alert 1: Status bit (read-only)
- 1 = TX > T_ALERT1
- 0 = TX ≤ T_ALERT1

Where: TX is either TH or TC (user-selectable, see Register 5-10).
5.2.2 THERMOCOUPLE SENSOR CONFIGURATION REGISTER

The MCP9600 Sensor Configuration register is used to select the thermocouple sensor types and to select the digital filter options. This device supports eight thermocouple types. Each type has a unique set of error correction coefficients that are derived from the NIST Thermocouple EMF Voltage Conversion database.

In addition, this device integrates a first order, recursive Infinite Impulse Response (IIR) filter, also known as Exponential Moving Average (EMA). The filter uses the current new temperature sample and the previous filter output to calculate the next filter output. It also adds more weight to the current temperature data, allowing a faster filter response to the immediate change in temperature. This feature can be used to filter out fast thermal transients or thermal instability at the thermocouple hot-junction temperature. Writing this register resets the filter.

The filter equation is shown in Equation 5-4 and the Filter Coefficient \( n \) is user-selectable, from Level 0 to 7. A coefficient of 0 disables the filter function and a 7 coefficient provides a maximum digital filter. Figure 5-6 shows the filter response to a step function, which can be used to extrapolate the filter performance to various temperature changes.

**EQUATION 5-4: DIGITAL FILTER**

\[
Y = k \times X + (1 - k) \times Y_{-1} \\
k = 2/(2^n + 1)
\]

Where:
- \( Y \) = New filtered temperature in \( T_\Delta \)
- \( X \) = Current, unfiltered hot-junction temperatures
- \( Y_{-1} \) = Previous filtered temperature
- \( n \) = User-selectable filter coefficient

**REGISTER 5-7: SENSOR CONFIGURATION REGISTER**

<table>
<thead>
<tr>
<th>U-0</th>
<th>R/W-0</th>
<th>R/W-0</th>
<th>R/W-0</th>
<th>U-0</th>
<th>R/W-0</th>
<th>R/W-0</th>
<th>R/W-0</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>Thermocouple Type Select, Type K, J, T, N, S, E, B, R</td>
<td></td>
<td>Filter Coefficients</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>bit 7</td>
<td></td>
<td></td>
<td></td>
<td>bit 0</td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

Legend:
- \( R \) = Readable bit
- \( W \) = Writable bit
- \( U \) = Unimplemented bit, read as ‘0’
- \( -n \) = Value at POR
- ‘1’ = Bit is set
- ‘0’ = Bit is cleared
- \( x \) = Bit is unknown

- **bit 7** Unimplemented: Read as ‘0’
- **bit 6-4** Thermocouple Type: Thermocouple Type Select bits
  - 000 = Type K
  - 001 = Type J
  - 010 = Type T
  - 011 = Type N
  - 100 = Type S
  - 101 = Type E
  - 110 = Type B
  - 111 = Type R
- **bit 3** Unimplemented: Read as ‘0’
- **bit 2-0** Filter Coefficient – \( n \): Filter Coefficient bits
  - 000 = \( n = 0 \): Filter off
  - 001 = \( n = 1 \): Minimum filter
  - 010 = \( n = 2 \)
  - 011 = \( n = 3 \)
  - 100 = \( n = 4 \): Mid filter
  - 101 = \( n = 5 \)
  - 110 = \( n = 6 \)
  - 111 = \( n = 7 \): Maximum filter

**FIGURE 5-6: Filter Step Response.**
5.2.3 DEVICE CONFIGURATION REGISTER

The device Configuration register allows the user to configure various functions, such as sensor measurement resolutions and Power modes. The Resolution register is used to select the sensor resolution for the desired temperature conversion time. When resolutions are changed, the change takes effect when the next measurement cycle begins.

This device integrates two Low-Power Operating modes: Shutdown mode and Burst mode, which can be selected using bit 0 and bit 1. When the Shutdown mode is executed, all power consuming activities are disabled and the operating current remains at $I_{\text{SHDN}}$. During the Shutdown mode, all registers are accessible; however, $I^2$C activity on the bus increases the current.

The Burst mode enables users to execute a given number of temperature samples (defined by bits<4-2>) before entering Shutdown mode. Each temperature sample is compared to the user-settable alert temperature limits, and if the alert conditions are true, then the device asserts the corresponding alert output. In addition, if the filter option is enabled, then the filter engine is applied to each temperature sample. The alert thresholds are also compared to the filtered temperature data. This feature is useful for battery power applications, where temperature is sampled upon request from the master controller.

**FIGURE 5-7:** Burst Mode Operation.

### REGISTER 5-8: DEVICE CONFIGURATION REGISTER

<table>
<thead>
<tr>
<th>R/W-0</th>
<th>Cold-Junction Resolution</th>
<th>R/W-0</th>
<th>ADC Measurement Resolution</th>
<th>R/W-0</th>
<th>Burst Mode Temperature Samples</th>
<th>R/W-0</th>
<th>Shutdown Modes</th>
</tr>
</thead>
</table>
| bit 7 | Cold-Junction/Ambient Sensor Resolution: Cold-Junction Resolution bit (see Table 5-2):  
0 = 0.0625°C  
1 = 0.25°C  
| bit 6-5 | ADC Measurement Resolution: ADC Resolution bits (see Table 5-3):  
00 = 18-bit Resolution  
01 = 16-bit Resolution  
10 = 14-bit Resolution  
11 =12-bit Resolution  
| bit 4-2 | Burst Mode Temperature Samples: Number of Temperature Samples bits  
000 = 1 sample  
001 = 2 samples  
010 = 4 samples  
011 = 8 samples  
100 = 16 samples  
101 = 32 samples  
110 = 64 samples  
111 = 128 samples  
| bit 1-0 | Shutdown Modes: Shutdown Mode bits  
00 = Normal operation  
01 = Shutdown mode  
10 = Burst mode  
11 = Unimplemented: this setting has no effect

**Legend:**

- R = Readable bit  
- W = Writable bit  
- U = Unimplemented bit, read as ‘0’  
- -n = Value at POR  
- ‘1’ = Bit is set  
- ‘0’ = Bit is cleared  
- x = Bit is unknown

The Burst mode enables users to execute a given number of temperature samples (defined by bits<4-2>) before entering Shutdown mode. Each temperature sample is compared to the user-settable alert temperature limits, and if the alert conditions are true, then the device asserts the corresponding alert output. In addition, if the filter option is enabled, then the filter engine is applied to each temperature sample. The alert thresholds are also compared to the filtered temperature data. This feature is useful for battery power applications, where temperature is sampled upon request from the master controller.
5.3 Temperature Alert Registers

This device provides four Temperature Alert registers that are individually configured, which allow users to monitor multiple temperature zones with a single device. The following sections describe each alert feature in detail.

5.3.1 ALERT LIMIT REGISTERS

This device integrates four individually controlled Temperature Alert Limit registers. Each alert limit is individually set to detect a rising or falling temperature, or either the Thermocouple Temperature (T_H) register or the Cold-Junction (T_C) register. The corresponding alert limit outputs can also be enabled for temperature status indicators. All alert functions are configured using the Alert Limit Configuration registers (Register 5-11) and the alert output hysteresis function is set using the Alert Hysteresis registers (Register 5-10).

<table>
<thead>
<tr>
<th>TABLE 5-4: ALARM LIMIT REGISTERS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Register</td>
</tr>
<tr>
<td>---------------------------</td>
</tr>
<tr>
<td>Alert 1 Limit – T_{ALERT1}</td>
</tr>
<tr>
<td>Alert 2 Limit – T_{ALERT2}</td>
</tr>
<tr>
<td>Alert 3 Limit – T_{ALERT3}</td>
</tr>
<tr>
<td>Alert 4 Limit – T_{ALERT4}</td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>REGISTER 5-9: ALERT LIMITS 1, 2, 3 AND 4 REGISTERS</th>
</tr>
</thead>
<tbody>
<tr>
<td>R/W-0</td>
</tr>
<tr>
<td>SIGN</td>
</tr>
<tr>
<td>bit 15</td>
</tr>
</tbody>
</table>

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | U-0   | U-0   |
| 8°C   | 4°C   | 2°C   | 1°C   | 0.5°C | 0.25°C| —     | —     |
| bit 7 |       |       |       |       |       |       |       |

Legend:

- R = Readable bit
- W = Writable bit
- U = Unimplemented bit, read as ‘0’
- -n = Value at POR
- ‘1’ = Bit is set
- ‘0’ = Bit is cleared
- x = Bit is unknown

bit 15  **SIGN**: Sign bit

- 1 = T_A < 0°C
- 0 = T_A ≥ 0°C

bit 14-2  **Alert 1, 2, 3 and 4**: Data in Two's Complement Format bits

bit 1-0  **Unimplemented**: Read as ‘0’
FIGURE 5-8: Alert Limits Set to Detect $T_H$ and $T_C$.

FIGURE 5-9: Alert Limits Boundary Conditions and Output Characteristics when Set to Detect $T_H$. 
5.3.2 ALERT HYSTERESIS REGISTER

This device integrates four individually controlled temperature Alert Hysteresis registers for each alert output, with a range of 0°C to +255°C.

The alert hysteresis directions are set using bit 3 of the corresponding Alert Configuration registers (Register 5-10) to detect rising or falling temperatures. For rising temperatures, the hysteresis range is below the alert limit where, as for falling temperatures, the hysteresis range is above the alert limit, as shown in Figure 5-10.

TABLE 5-5: ALERT HYSTERESIS REGISTERS

<table>
<thead>
<tr>
<th>Register</th>
<th>Register Pointer</th>
</tr>
</thead>
<tbody>
<tr>
<td>Alert 1 Hysteresis – THYST1</td>
<td>0000 1100</td>
</tr>
<tr>
<td>Alert 2 Hysteresis – THYST2</td>
<td>0000 1101</td>
</tr>
<tr>
<td>Alert 3 Hysteresis – THYST3</td>
<td>0000 1110</td>
</tr>
<tr>
<td>Alert 4 Hysteresis – THYST4</td>
<td>0000 1111</td>
</tr>
</tbody>
</table>

REGISTER 5-10: THYSTx: ALERT 1, 2, 3 AND 4 HYSTERESIS REGISTERS

<table>
<thead>
<tr>
<th>R/W-0</th>
<th>R/W-0</th>
<th>R/W-0</th>
<th>R/W-0</th>
<th>R/W-0</th>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
</tr>
</thead>
<tbody>
<tr>
<td>128°C</td>
<td>64°C</td>
<td>32°C</td>
<td>16°C</td>
<td>8°C</td>
<td>4°C</td>
<td>2°C</td>
<td>1°C</td>
</tr>
</tbody>
</table>

Legend:
R = Readable bit  
W = Writable bit  
U = Unimplemented bit, read as ‘0’

- n = Value at POR  
‘1’ = Bit is set  
‘0’ = Bit is cleared  
x = Bit is unknown

bit 7-0 Alert Hysteresis: Alert Hysteresis Range 0x00 to 0xFF bits (which represents +1°C to +255°C)

FIGURE 5-10: Graphical Description of Alert Output Hysteresis Direction.
5.3.3 ALERT CONFIGURATION REGISTERS

This device integrates four individually controlled temperature alert outputs. Each output is configured for the corresponding alert output using the Alert Output Configuration registers.

The Configuration registers are used to enable each output, select the Alert Function mode as Comparator or Interrupt mode, active-high or active-low output, detect rising or falling temperatures and detect \( T_H \) or \( T_C \) Temperature registers.

The Comparator mode is useful for thermostat-type applications, such as on/off switches for fan controllers, buzzer or LED indicators. The alert output asserts and deasserts when the temperature exceeds the user-specified limit, and the user-specified hysteresis limit. The Interrupt mode is useful for interrupt driven microcontroller-based systems. The alert outputs are asserted each time the temperature exceeds the user-specified alert limit and hysteresis limits.

TABLE 5-6: ALERT CONFIG. REGISTERS

<table>
<thead>
<tr>
<th>Register</th>
<th>Register Pointer</th>
</tr>
</thead>
<tbody>
<tr>
<td>Alert 1</td>
<td>0000 1000</td>
</tr>
<tr>
<td>Alert 2</td>
<td>0000 1001</td>
</tr>
<tr>
<td>Alert 3</td>
<td>0000 1010</td>
</tr>
<tr>
<td>Alert 4</td>
<td>0000 1011</td>
</tr>
</tbody>
</table>

REGISTER 5-11: ALERT 1, 2, 3 AND 4 CONFIGURATION REGISTER

<table>
<thead>
<tr>
<th>R/W-0</th>
<th>U-0</th>
<th>U-0</th>
<th>R/W-0</th>
<th>R/W-0</th>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
</tr>
</thead>
<tbody>
<tr>
<td>Interrupt Clear</td>
<td>—</td>
<td>—</td>
<td>Monitor ( T_H/T_C )</td>
<td>Rise/Fall</td>
<td>Active-High/Low</td>
<td>Comp/Int.</td>
<td>Alert Enable</td>
</tr>
<tr>
<td>bit 7</td>
<td></td>
<td></td>
<td>bit 0</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

Legend:

- **R** = Readable bit
- **W** = Writable bit
- **U** = Unimplemented bit, read as ‘0’
- \(-n\) = Value at POR
- ‘1’ = Bit is set
- ‘0’ = Bit is cleared
- \(x\) = Bit is unknown

bit 7 Interrupt Clear: Interrupt Clear bit

1  = Clears Interrupt flag (forced ‘0’ by device)
0  = Normal state or cleared state

bit 6-5 Unimplemented: Read as ‘0’

bit 4 Monitor \( T_H \) or \( T_C \): Temperature Maintain/Detect bit

1  = Alert monitor for \( T_C \) cold-junction sensor
0  = Alert monitor for \( T_H \) thermocouple temperature

bit 3 Rise/Fall: Alert Temperature Direction bit

1  = Alert limit for rising or heating temperatures
0  = Alert limit for falling or cooling temperatures

bit 2 Active-High/Low: Alert State bit

1  = Active-high
0  = Active-low

bit 1 Comp./Int.: Alert Mode bit

1  = Interrupt mode: Interrupt clears bit (bit 7) – must be set to deassert the alert output
0  = Comparator mode

bit 0 Alert Enable: Alert Output Enable bit

1  = Alert output is enabled
0  = Alert output is disabled

The microcontroller will have Acknowledged the interrupt signal from the corresponding alert output by clearing the interrupt using bit 7 of the corresponding Configuration register.

The Rise/Fall bit (bit 3) and the Monitor \( T_H/T_C \) bit (bit 4) can be used to detect and maintain the thermocouple temperature or the cold-junction temperature to the desired temperature window.
5.3.4 DEVICE ID AND REVISION ID REGISTER

The Device ID and Revision ID register is a 16-bit read-only register, which can be used to identify this device among other devices on the I²C bus. The upper 8 bits indicate the Device ID of 0x40, while the lower 8 bits indicate the device revision. The device revision byte is divided into nibbles, where the upper nibble indicates the major revision and the lower nibble indicates minor revisions for each major revision. The initial release is indicated by a major revision of ‘1’ and a minor revision of ‘0’ or 0x4010.

REGISTER 5-12: DEVICE ID AND REVISION ID REGISTER

<table>
<thead>
<tr>
<th>R-0</th>
<th>R-1</th>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Device ID</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>bit 15</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
<th>R-1</th>
<th>R-0</th>
<th>R-0</th>
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<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Major</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>bit 7</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
<th>R-0</th>
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</thead>
<tbody>
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<td></td>
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<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Minor</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>bit 0</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

Legend:

R = Readable bit  W = Writable bit  U = Unimplemented bit, read as ‘0’
-n = Value at POR  ‘1’ = Bit is set  ‘0’ = Bit is cleared  x = Bit is unknown

bit 15-8  **Device ID**: Device ID bits (0x40, Hex)
bit 7-0   **Revision**: Major/Minor Revision ID bits (0x10, Hex)

Release, Revision 1.0.
6.0 APPLICATION INFORMATION

6.1 Layout Considerations

The MCP9600 does not require any additional components to digitize thermocouples. However, it is recommended that a decoupling capacitor of 0.1 µF to 1 µF be used between the V DD and GND pins. A high-frequency ceramic capacitor is recommended. It is necessary for the capacitor to be located as close as possible to the V DD and ground pins of the device in order to provide effective noise protection.

In addition, good PCB layout is key for better thermal conduction from the PCB temperature to the sensor die. The PCB provides thermal conduction from the die to the thermocouple cold-junction; therefore, the component placement positioning and the copper layout techniques are key for optimum cold-junction compensation. The recommended implementation for optimum temperature sensitivity is to extend a copper ground pad around the device pins, as shown in Figure 6-1.

![Recommended PCB Layout](image)

**FIGURE 6-1:** Recommended PCB Layout.

6.1.1 COLD-JUNCTION COMPENSATION

Copper provides better thermal conductivity than PCB FR4 to the ambient temperature. It also provides better thermal conduction than the 5 mm x 5 mm MQFN plastic package, which houses the temperature sensor die. Therefore, when connecting the thermocouple wire to the PCB, it is recommended to place the ground copper between the thermocouple connector footprint, where dissimilar conductive material is attached to the PCB and the MCP9600 exposed pad. This allows temperature to stabilize to the local ambient temperature (between the thermocouple connector junction and the PCB copper) and the copper trace conducts the temperature to the package exposed pad where the temperature sensor die is placed. The placement of the sensor exposed pad to the thermocouple connector junction greatly determines the temperature sensor’s sensitivity to the local junction temperature changes. Figure 6-2 demonstrates the recommended techniques.

![Recommended Component Placement](image)

**FIGURE 6-2:** Recommended Component Placement.

6.2 Thermal Considerations

The potential for self-heating errors exist if the MCP9600 SDA, SCL and alert outputs are heavily loaded (high current) with pull-up resistors and circuits, such as high-current LEDs or buzzer loads. The temperature rise due to self-heat increases the ambient temperature sensor output, resulting in an increased temperature offset error compared to the thermocouple cold-junction ambient temperature.

6.2.1 SELF-HEAT DURING OPERATION

During normal operation, the typical self-heating error is negligible due to the relatively small current consumption of the MCP9600. However, this device integrates a processor to compute the equations necessary to convert the thermocouple EMF voltage to degrees Celsius. The processor also maintains the I²C bus. During I²C communication, the device operating current increases to $I_{DD} = 1.5 \, mA$ (typical), I²C Active specification. If the bus is continually polled for data at frequent intervals, then the processor power dissipates heat to the temperature sensor and the effect of self-heat can be detected. Therefore, the recommended implementation is to maintain polling to no more than three times per temperature conversion period of 320 ms or use the Burst mode feature to manage self-heat (refer to Section 6.2.3 “Using Burst Mode to Manage Self-Heat”). Equation 6-1 can also be used to determine the effect of self-heat.
EQUATION 6-1: EFFECT OF SELF-HEATING

\[ T_A = \theta_{JA}(V_{DD} \cdot I_{DD}) \]
\[ T_A = \theta_{JC}(V_{DD} \cdot I_{DD}) \]
\[ T_A = T_J - T_A \]

Where:
- \( T_J \) = Junction Temperature
- \( T_A \) = Ambient Temperature
- \( \theta_{JA} \) = Package Thermal Resistance:
  - Junction to Ambient
- \( \theta_{JC} \) = Package Thermal Resistance:
  - Junction to Case

At room temperature \((T_A = +25^\circ C)\) with \(I_{DD} = 2.5\) mA (maximum) and \(V_{DD} = 3.3\) V, the self-heating due to power dissipation, \(T_A\), is 0.32°C for the MQFN package.

### 6.2.2 CONVERSION TIME vs. SELF-HEAT

Once the ADC completes digitization, the processor initiates the data computation routine for \(t_{CALC}\), which also increases \(I_{DD}\). During the 18-bit ADC conversion time (3 SPS, Samples per Second), the increased current lasts for approximately 5% of the one-second period. The effect of self-heat for the total power consumed per second, including the 5% \(t_{CALC}\) period, is negligible. However, as the ADC resolution is reduced from 18-bit to 16-bit, the power consuming \(t_{CALC}\) period increases to 20% per second. This change in resolution adds approximately 0.04°C (typical) temperature error due to self-heat. Table 6-1 provides an estimate for self-heat for all resolutions using Equation 6-1.

In order to reduce the effects of self-heat for lower resolution settings, the Burst mode feature is recommended to manage the effects of self-heat.

### TABLE 6-1: ADC RESOLUTION vs. SELF-HEAT

<table>
<thead>
<tr>
<th>Resolution (typ.)</th>
<th>SPS (typ.)</th>
<th>( t_{CALC} ) Duration per Second</th>
<th>( T_A )</th>
</tr>
</thead>
<tbody>
<tr>
<td>18 bit</td>
<td>3</td>
<td>5%</td>
<td>0.0096°C</td>
</tr>
<tr>
<td>16 bit</td>
<td>15</td>
<td>20%</td>
<td>0.0384°C</td>
</tr>
<tr>
<td>14 bit</td>
<td>60</td>
<td>80%</td>
<td>0.1536°C</td>
</tr>
<tr>
<td>12 bit</td>
<td>240</td>
<td>100%</td>
<td>0.1920°C</td>
</tr>
</tbody>
</table>

Note: \( V_{DD} = 3.3\) V and \( I_{DD} = 1.5\) mA (typical).

### 6.2.3 USING BURST MODE TO MANAGE SELF-HEAT

The Burst mode feature is useful to manage power dissipation while maintaining the device sensitivity to changes in temperature (see Section 5.2.3 “Device Configuration Register”). While the device is in Low-Power or Shutdown mode, the master controller executes Burst mode to sample temperature. The number of temperature samples and the measurement resolution settings are selected while executing the command. While in Burst mode, if the temperature data exceeds the alert limits, the device asserts the corresponding alert output. The alert outputs are used so the master controller does not need to continually poll the latest temperature data and potentially increase the temperature error.

In addition, with some applications monitoring several hundred degrees of temperature changes, 18-bit resolution may not be necessary. In this case, a fewer number of burst samples reducing the resolution enables the user to monitor fast transient temperatures at the burst intervals. The 12-bit ADC resolution provides approximately 3°C resolution (for Type K) and a new sample of temperature data is computed at approximately 20 ms intervals. Therefore, the number of Burst mode Samples per Second can be selected to manage the effects of self-heat using these estimates.

The temperature conversion status during Burst mode can also be momentarily polled (using bit 7 of Register 5-6) to detect whether the on-going sample bursts are completed. The master controller may terminate an on-going burst by executing a shutdown command or resetting the Burst mode by sending another burst command.

### 6.2.4 ALERT OUTPUTS

The alert outputs are intended to drive high-impedance loads. Typically, the outputs are connected to a microcontroller input pin. However, if the outputs are used to drive indicators, such as LEDs or buzzers, then a buffer circuit is recommended in order to minimize the effects of self-heat due to the applied load (see Figure 6-3).

![Alert Output Buffer](image-url)
6.3 Device Features

6.3.1 I²C ADDRESSING

The MCP9600 supports up to eight devices on the I²C bus. Applications, such as large thermal management racks with several thermocouple sensor interfaces, are able to monitor various temperature zones with minimal pin count microcontrollers. This reduces the total solution cost, while providing a highly accurate thermal management solution using the MCP9600.

FIGURE 6-4: I²C Address Selection Implementation.

6.3.2 INPUT IMPEDANCE

The MCP9600 uses a switched capacitor amplifier input stage to gain the input signal to a maximum resolution of 2 µV/LSb at an 18-bit ADC setting. An internal input capacitor is used for charge storage. The differential input impedance, ZIN, is dominated by the sampling capacitor and the switched capacitor amplifier sampling frequency. During a sampling period, the charging and discharging of the sampling capacitor creates dynamic input currents at the input pins. Adding a 10-100 nF capacitor between the inputs can improve stability.

Since the sampling capacitor is only switching to the input pins during a conversion process, the input impedance is only valid during conversion periods. During Low-Power or Shutdown mode, the input amplifier stage is disabled; therefore, the input impedance is ZIN_CM, which is due to the leakage current from ESD protection diodes, as shown in Figure 6-5.

FIGURE 6-5: Thermocouple Input Stage.

6.3.3 OPEN AND SHORT DETECTION CIRCUITS

External circuits can be added to detect the thermocouple status as open (physically disconnected) or as short (thermocouple wire in contact with the system ground or VDD). If a passive circuit is added to the input stage, then the circuit loading effect to the MCP9600 ADC inputs must be considered. System calibration is also required to ensure proper accuracy. In addition, external loads can degrade the device performance, such as input offset, gain and Integral Nonlinearity (INL) errors. If a low-impedance active circuit is added, then both offset and gain errors must be calibrated.

TABLE 6-2: RECOMMENDED RESISTOR VALUES FOR I²C ADDRESSING

<table>
<thead>
<tr>
<th>Device #</th>
<th>Command Byte</th>
<th>Values</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td></td>
<td>RxA (kΩ)</td>
</tr>
<tr>
<td>1</td>
<td>1100 000x</td>
<td>ADDR Pin Tied to GND</td>
</tr>
<tr>
<td>2</td>
<td>1100 001x</td>
<td>R3A = 10</td>
</tr>
<tr>
<td>3</td>
<td>1100 010x</td>
<td>R3A = 10</td>
</tr>
<tr>
<td>4</td>
<td>1100 011x</td>
<td>R4A = 10</td>
</tr>
<tr>
<td>5</td>
<td>1100 100x</td>
<td>R5A = 10</td>
</tr>
<tr>
<td>6</td>
<td>1100 101x</td>
<td>R6A = 10</td>
</tr>
<tr>
<td>7</td>
<td>1100 110x</td>
<td>R7A = 10</td>
</tr>
<tr>
<td>8</td>
<td>1100 111x</td>
<td>ADDR Pin Tied to VDD</td>
</tr>
</tbody>
</table>

Note: Standard 5% tolerance resistors are used in the table; however, 1% tolerance resistors provide better ratio matching.

FIGURE 6-4: I²C Address Selection Implementation.

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6.3.3.1 Open-Circuit Detection Technique

For open-circuit detection, the Input Range Flag bit, bit 4 of the STATUS register (Register 5-6), can be used to detect open-circuit conditions. This would require a few external resistors, as shown in Figure 6-6. The passive circuit does not affect the MCP9600 accuracy (the recommended value for \( R_B \) is set to 1 M\( \Omega \)). When the thermocouple is connected, the input Common-mode voltage is 0.5 \( \times \) \( V_{DD} \). When the thermocouple is disconnected, the voltage at the \( V_{IN+} \) input is 0.66 \( \times \) \( V_{DD} \) and the voltage at the \( V_{IN-} \) input is pulled down to \( V_{SS} \). This change forces the Input Range Flag bit to be set. The master controller can momentarily poll the Status bit to detect the open-circuit condition.

**FIGURE 6-6:** Adding Open-Circuit Detection Resistors.

6.3.4 Aliasing and Anti-Aliasing Filter

Aliasing occurs when the input signal contains time varying signals with frequency greater than half the sample rate. In the aliasing conditions, the ADC can output unexpected codes. The ADC integrates a first order sync filter; however, an external anti-aliasing filter can provide an added filter for high noise applications. This can be done with a simple RC low-pass filter at the inputs, as shown in Figure 6-7. Open-circuit detection resistors can also be added, as shown in Figure 6-8.

**FIGURE 6-7:** Adding a Low-Pass Filter.

6.3.5 ESD Protection Using Ferrite Beads

Ferrite beads are highly recommended to protect the MCP9600 and other circuits from ESD discharge through the thermocouple wire. The beads suppress fast transient signals, such as ESD, and can be added in-line to the ADC inputs. In addition, protection diodes are also recommended, as shown in Figure 6-9.

**FIGURE 6-9:** Adding Ferrite Beads.
7.0 PACKAGING INFORMATION

7.1 Package Marking Information

Legend:
- **XX...X**: Customer-specific information
- **Y**: Year code (last digit of calendar year)
- **YY**: Year code (last 2 digits of calendar year)
- **WW**: Week code (week of January 1 is week ‘01’)
- **NNN**: Alphanumeric traceability code
- **e3**: Pb-free JEDEC® designator for Matte Tin (Sn)

*This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package.*

**Note:** In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.
20-Lead More Thin Plastic Quad Flat, No Lead Package (NU) - 5x5x1.0 mm Body [MQFN] - (Also called VQFN)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging

Microchip Technology Drawing C04-186A Sheet 1 of 2
### 20-Lead More Thin Plastic Quad Flat, No Lead Package (NU) - 5x5x1.0 mm Body
**[MQFN]** - (Also called VQFN)

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at [http://www.microchip.com/packaging](http://www.microchip.com/packaging)

<table>
<thead>
<tr>
<th>Dimension</th>
<th>Units</th>
<th>MIN</th>
<th>NOM</th>
<th>MAX</th>
</tr>
</thead>
<tbody>
<tr>
<td>Number of Pins</td>
<td>N</td>
<td>20</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Pitch</td>
<td>e</td>
<td>0.65 BSC</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Overall Height</td>
<td>A</td>
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<td>0.20 REF</td>
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<tr>
<td>Overall Length</td>
<td>D</td>
<td>3.15</td>
<td>3.25</td>
<td>3.35</td>
</tr>
<tr>
<td>Exposed Pad Length</td>
<td>D2</td>
<td>5.00 BSC</td>
<td></td>
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<tr>
<td>Overall Width</td>
<td>E</td>
<td>3.15</td>
<td>3.25</td>
<td>3.35</td>
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<tr>
<td>Exposed Pad Width</td>
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<td>5.00 BSC</td>
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<td>Terminal Width</td>
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<tr>
<td>Terminal Length</td>
<td>L</td>
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<td>0.40</td>
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<tr>
<td>Terminal-to-Exposed-Pad</td>
<td>K</td>
<td>0.20</td>
<td>-</td>
<td>-</td>
</tr>
</tbody>
</table>

**Notes:**
1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated
3. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.
20-Lead More Thin Plastic Quad Flat, No Lead Package (NU) - 5x5x1.0 mm Body [MQFN] - (Also called VQFN)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging

RECOMMENDED LAND PATTERN

<table>
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<tr>
<th>Units</th>
<th>MILLIMETERS</th>
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<tbody>
<tr>
<td>Dimension Limits</td>
<td>MIN</td>
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<tr>
<td>Contact Pitch</td>
<td>E</td>
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<tr>
<td>Optional Center Pad Width</td>
<td>W2</td>
</tr>
<tr>
<td>Optional Center Pad Length</td>
<td>T2</td>
</tr>
<tr>
<td>Contact Pad Spacing</td>
<td>C1</td>
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<tr>
<td>Contact Pad Spacing</td>
<td>C2</td>
</tr>
<tr>
<td>Contact Pad Width (X20)</td>
<td>X1</td>
</tr>
<tr>
<td>Contact Pad Length (X20)</td>
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<tr>
<td>Distance Between Pads</td>
<td>G</td>
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<tr>
<td>Thermal Via Diameter</td>
<td>V</td>
</tr>
<tr>
<td>Thermal Via Pitch</td>
<td>EV</td>
</tr>
</tbody>
</table>

Notes:
1. Dimensioning and tolerancing per ASME Y14.5M
   BSC: Basic Dimension. Theoretically exact value shown without tolerances.
2. For best soldering results, thermal vias, if used, should be filled or tented to avoid solder loss during reflow process

Microchip Technology Drawing C04-286B
APPENDIX A: REVISION HISTORY

Revision C (September 2017)

The following is the list of modifications:
1. Updated Figure 4-3, Equation 5-1, Equation 5-2 and Equation 5-3.
2. Updated Section 6.3.3.1 “Open-Circuit Detection Technique”.
3. Various typographical edits.

Revision B (June 2016)

The following is the list of modifications:
1. Corrected the pin description error for pins 19 and 20 on page 1.
2. Added the MCP9600 Evaluation Board picture on page 2.
3. Added Section 6.3.3.1 “Open-Circuit Detection Technique” and updated Section 6.3.4 “Aliasing and Anti-Aliasing Filter” and Section 6.3.5 “ESD Protection Using Ferrite Beads”.
4. Updated the Product Identification System section.

Revision A (August 2015)

• Original Release of this Document.
PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

<table>
<thead>
<tr>
<th>PART NO.</th>
<th>[X] (2)</th>
<th>X</th>
<th>/XX</th>
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<tbody>
<tr>
<td>Device</td>
<td>Tape and Reel Option</td>
<td>Temperature Range</td>
<td>Package</td>
</tr>
</tbody>
</table>

**Device:**
- MCP9600: Signal Conditioning IC
- MCP9600T: Signal Conditioning IC (Tape and Reel)

**Tape and Reel Option:**
- T = Tape and Reel

**Temperature Range:**
- E = -40°C to +125°C

**Package:**
- MX = More Thin Plastic Quad Flat, MQFN, 20-Lead

**Examples:**

<table>
<thead>
<tr>
<th>Device</th>
<th>Tape and Reel Option</th>
<th>Temperature Range</th>
<th>Package</th>
<th>Options</th>
</tr>
</thead>
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<tr>
<td>MCP9600-E/MX</td>
<td>Extended temperature, 20-lead MQFN package</td>
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<tr>
<td>MCP9600T-E/MX</td>
<td>Tape and Reel, Extended temperature, 20-lead MQFN package</td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

**Note 1:** For custom thermocouple types or custom features, please contact your local Microchip Sales office. Minimum purchase volumes are required.

**Note 2:** Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check with your Microchip Sales Office for package availability with the Tape and Reel option.
Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
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